

In the Specification

Before the first paragraph, please insert:

This application is a divisional application of U.S. Application Serial No. 09/949,251 filed on September 7, 2001, entitled "Thin Film Magnetic Head Having Partial Insulating Layer Formed on Bottom Pole Layer Through Gap Layer and Method of Manufacturing the Same".

PC
3/15/06

now US. Pat. 6,999,275